



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

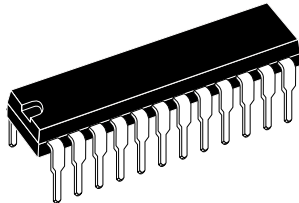
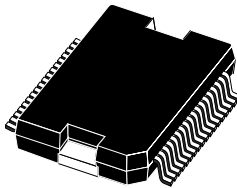
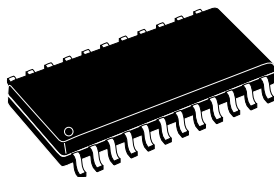
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



DMOS driver for 3-phase brushless DC motor

Datasheet - production data

**PowerDIP24**
(20 + 2 + 2)**PowerSO36****SO24**
(20 + 2 + 2)**Ordering numbers:**
L6235N (PowerDIP24)
L6235PD (PowerSO36)
L6235D (SO24)**Features**

- Operating supply voltage from 8 to 52 V
- 5.6 A output peak current (2.8 A DC)
- $R_{DS(ON)}$ 0.3 Ω typ. value at $T_j = 25^\circ\text{C}$
- Operating frequency up to 100 KHz
- Non-dissipative overcurrent detection and protection
- Diagnostic output
- Constant t_{OFF} PWM current controller
- Slow decay synchr. rectification
- 60° and 120° hall effect decoding logic
- Brake function
- Tachometer output for speed loop
- Cross conduction protection
- Thermal shutdown
- Undervoltage lockout
- Integrated fast freewheeling diodes

Description

The L6235 device is a DMOS fully integrated 3-phase motor driver with overcurrent protection.

Realized in BCD technology, the device combines isolated DMOS power transistors with CMOS and bipolar circuits on the same chip.

The device includes all the circuitry needed to drive a 3-phase BLDC motor including: a 3-phase DMOS bridge, a constant off time PWM current controller and the decoding logic for single ended hall sensors that generates the required sequence for the power stage.

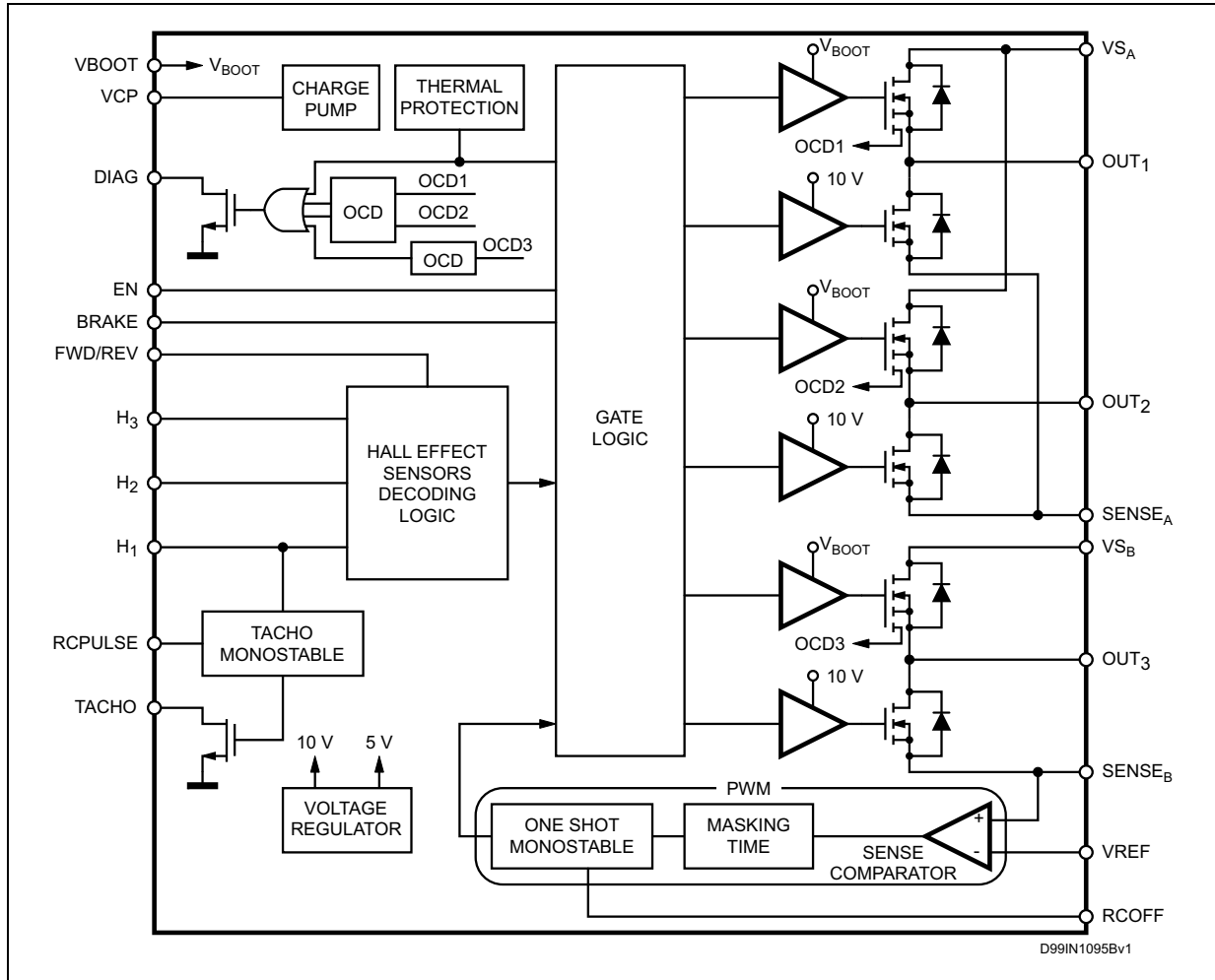
Available in PowerDIP24 (20 + 2 + 2), PowerSO36 and SO24 (20 + 2 + 2) packages, the L6235 device features a non-dissipative overcurrent protection on the high-side power MOSFETs and thermal shutdown.

Contents

1	Block diagram	3
2	Maximum ratings	4
3	Pin connections	6
4	Electrical characteristics	8
5	Circuit description	11
	5.1 Power stages and charge pump	11
	5.2 Logic inputs	12
6	PWM current control	13
7	Slow decay mode	17
8	Decoding logic	18
9	Tachometer	20
10	Non-dissipative overcurrent detection and protection	22
11	Application information	25
	11.1 Output current capability and IC power dissipation	26
	11.2 Thermal management	27
12	Package information	30
13	Revision history	34

1 Block diagram

Figure 1. Block diagram



2 Maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Test conditions	Value	Unit
V_S	Supply voltage	$V_{SA} = V_{SB} = V_S$	60	V
V_{OD}	Differential voltage between: V_{SA} , OUT_1 , OUT_2 , $SENSE_A$ and V_{SB} , OUT_3 , $SENSE_B$	$V_{SA} = V_{SB} = V_S = 60\text{ V}$; $V_{SENSE_A} = V_{SENSE_B} = \text{GND}$	60	V
V_{BOOT}	Bootstrap peak voltage	$V_{SA} = V_{SB} = V_S$	$V_S + 10$	V
V_{IN} , V_{EN}	Logic inputs voltage range		-0.3 to 7	V
V_{REF}	Voltage range at pin VREF		-0.3 to 7	V
V_{RCOFF}	Voltage range at pin RCOFF		-0.3 to 7	V
$V_{RCPULSE}$	Voltage range at pin RCPULSE		-0.3 to 7	V
V_{SENSE}	Voltage range at pins $SENSE_A$ and $SENSE_B$		-1 to 4	V
$I_{S(\text{peak})}$	Pulsed supply current (for each V_{SA} and V_{SB} pin)	$V_{SA} = V_{SB} = V_S$; $T_{PULSE} < 1\text{ ms}$	7.1	A
I_S	DC supply current (for each V_{SA} and V_{SB} pin)	$V_{SA} = V_{SB} = V_S$	2.8	A
T_{stg} , T_{OP}	Storage and operating temperature range		-40 to 150	°C

Table 2. Recommended operating condition

Symbol	Parameter	Test conditions	Min.	Max.	Unit
V_S	Supply voltage	$V_{SA} = V_{SB} = V_S$	12	52	V
V_{OD}	Differential voltage between: V_{SA} , OUT_1 , OUT_2 , $SENSE_A$ and V_{SB} , OUT_3 , $SENSE_B$	$V_{SA} = V_{SB} = V_S$; $V_{SENSE_A} = V_{SENSE_B}$		52	V
V_{REF}	Voltage range at pin VREF		-0.1	5	V
V_{SENSE}	Voltage range at pins $SENSE_A$ and $SENSE_B$	(pulsed $t_W < t_{rr}$) (DC)	-6 -1	6 1	V V
I_{OUT}	DC output current	$V_{SA} = V_{SB} = V_S$		2.8	A
T_J	Operating junction temperature		-25	125	°C
f_{SW}	Switching frequency			100	KHz

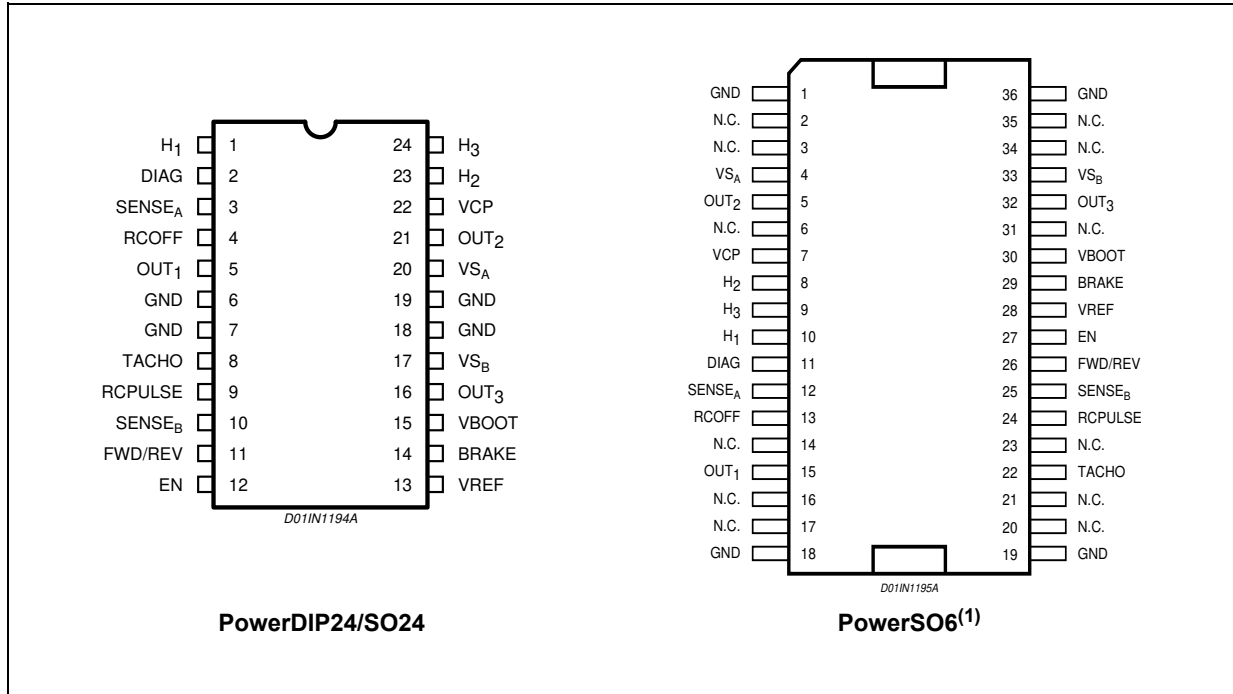
Table 3. Thermal data

Symbol	Description	PDIP24	SO24	PowerSO36	Unit
$R_{th(j-pins)}$	Maximum thermal resistance junction pins	18	14		°C/W
$R_{th(j-case)}$	Maximum thermal resistance junction case			1	°C/W
$R_{th(j-amb)1}$	Maximum thermal resistance junction ambient ⁽¹⁾	43	51	-	°C/W
$R_{th(j-amb)1}$	Maximum thermal resistance junction ambient ⁽²⁾	-	-	35	°C/W
$R_{th(j-amb)1}$	Maximum thermal resistance junction ambient ⁽³⁾	-	-	15	°C/W
$R_{th(j-amb)2}$	Maximum thermal resistance junction ambient ⁽⁴⁾	58	77	62	°C/W

1. Mounted on a multilayer FR4 PCB with a dissipating copper surface on the bottom side of 6 cm² (with a thickness of 35 μm).
2. Mounted on a multilayer FR4 PCB with a dissipating copper surface on the top side of 6 cm² (with a thickness of 35 μm).
3. Mounted on a multilayer FR4 PCB with a dissipating copper surface on the top side of 6 cm² (with a thickness of 35 μm), 16 via holes and a ground layer.
4. Mounted on a multilayer FR4 PCB without any heatsinking surface on the board.

3 Pin connections

Figure 2. Pin connections (top view)



1. The slug is internally connected to pins 1, 18, 19 and 36 (GND pins).

Table 4. Pin description

Package		Name	Type	Function
SO24/ PowerDIP24	PowerSO36			
Pin no.	Pin no.			
1	10	H ₁	Sensor input	Single ended hall effect sensor input 1.
2	11	DIAG	Open drain output	Overcurrent detection and thermal protection pin. An internal open drain transistor pulls to GND when an overcurrent on one of the high-side MOSFETs is detected or during thermal protection.
3	12	SENSE _A	Power supply	Half-bridge 1 and half-bridge 2 source pin. This pin must be connected together with pin SENSE _B to power ground through a sensing power resistor.
4	13	RCOFF	RC pin	RC network pin. A parallel RC network connected between this pin and ground sets the current controller OFF-time.
5	15	OUT ₁	Power output	Output 1

Table 4. Pin description (continued)

Package		Name	Type	Function
SO24/ PowerDIP24	PowerSO36			
Pin no.	Pin no.			
6, 7, 18, 19	1, 18, 19, 36	GND	GND	Ground terminals. On PowerDIP24 and SO24 packages, these pins are also used for heat dissipation toward the PCB. On PowerSO36 package the slug is connected on these pins.
8	22	TACHO	Open drain output	Frequency-to-voltage open drain output. Every pulse from pin H ₁ is shaped as a fixed and adjustable length pulse.
9	24	RCPULSE	RC pin	RC network pin. A parallel RC network connected between this pin and ground sets the duration of the monostable pulse used for the frequency-to-voltage converter.
10	25	SENSE _B	Power supply	Half-bridge 3 source pin. This pin must be connected together with pin SENSE _A to power ground through a sensing power resistor. At this pin also the inverting input of the sense comparator is connected.
11	26	FWD/REV	Logic input	Selects the direction of the rotation. HIGH logic level sets forward operation, whereas LOW logic level sets reverse operation. If not used, it has to be connected to GND or +5 V.
12	27	EN	Logic input	Chip enable. LOW logic level switches OFF all power MOSFETs. If not used, it has to be connected to +5 V.
13	28	VREF	Logic input	Current controller reference voltage. Do not leave this pin open or connect to GND.
14	29	BRAKE	Logic input	Brake input pin. LOW logic level switches ON all high-side Power MOSFETs, implementing the brake function. If not used, it has to be connected to +5 V.
15	30	VBOOT	Supply voltage	Bootstrap voltage needed for driving the upper Power MOSFETs.
16	32	OUT ₃	Power output	Output 3.
17	33	VS _B	Power supply	Half-bridge 3 power supply voltage. It must be connected to the supply voltage together with pin VS _A .
20	4	VS _A	Power supply	Half-bridge 1 and half-bridge 2 power supply voltage. It must be connected to the supply voltage together with pin VS _B .
21	5	OUT ₂	Power output	Output 2.
22	7	VCP	Output	Charge pump oscillator output.
23	8	H ₂	Sensor input	Single ended hall effect sensor input 2.
24	9	H ₃	Sensor input	Single ended hall effect sensor input 3.

4 Electrical characteristics

Table 5. Electrical characteristics
($V_S = 48\text{ V}$, $T_{\text{amb}} = 25\text{ °C}$, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{\text{Sth(ON)}}$	Turn ON threshold		6.6	7.4		V
$V_{\text{Sth(OFF)}}$	Turn OFF threshold		5.6	6	6.4	V
I_S	Quiescent supply current	All bridges OFF; $T_j = -25\text{ to }125\text{ °C}^{(1)}$		5	10	mA
$T_{\text{J(OFF)}}$	Thermal shutdown temperature			165		°C
Output DMOS transistors						
$R_{\text{DS(ON)}}$	High-side switch ON resistance	$T_j = 25\text{ °C}$		0.34	0.4	Ω
		$T_j = 125\text{ °C}^{(1)}$		0.53	0.59	Ω
	Low-side switch ON resistance	$T_j = 25\text{ °C}$		0.28	0.34	Ω
		$T_j = 125\text{ °C}^{(1)}$		0.47	0.53	Ω
I_{DSS}	Leakage current	EN = low; OUT = V_{CC}			2	mA
		EN = low; OUT = GND	-0.15			mA
Source drain diodes						
V_{SD}	Forward ON voltage	$I_{\text{SD}} = 2.8\text{ A}$, EN = LOW		1.15	1.3	V
t_{rr}	Reverse recovery time	$I_f = 2.8\text{ A}$		300		ns
t_{fr}	Forward recovery time			200		ns
Logic input (H1, H2, H3, EN, FWD/REV, BRAKE)						
V_{IL}	Low level logic input voltage		-0.3		0.8	V
V_{IH}	High level logic input voltage		2		7	V
I_{IL}	Low level logic input current	GND logic input voltage	-10			μA
I_{IH}	High level logic input current	7 V logic input voltage			10	μA
$V_{\text{th(ON)}}$	Turn-ON input threshold			1.8	2.0	V
$V_{\text{th(OFF)}}$	Turn-OFF input threshold		0.8	1.3		V
V_{thHYS}	Input thresholds hysteresis		0.25	0.5		V
Switching characteristics						
$t_{\text{D(on)EN}}$	Enable to out turn-ON delay time ⁽²⁾	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load	110	250	400	ns
$t_{\text{D(off)EN}}$	Enable to out turn-OFF delay time ⁽²⁾	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load	300	550	800	ns
$t_{\text{D(on)IN}}$	Other logic inputs to output turn-ON delay time	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load			2	μs
$t_{\text{D(off)IN}}$	Other logic inputs to out turn-OFF delay time	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load			2	μs
t_{RISE}	Output rise time ⁽²⁾	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load	40		250	ns
t_{FALL}	Output fall time ⁽²⁾	$I_{\text{LOAD}} = 2.8\text{ A}$, resistive load	40		250	ns
t_{DT}	Deadtime		0.5	1		μs
f_{CP}	Charge pump frequency	$T_j = -25\text{ to }125\text{ °C}^{(1)}$		0.6	1	MHz

Table 5. Electrical characteristics (continued)
 ($V_S = 48\text{ V}$, $T_{\text{amb}} = 25\text{ °C}$, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
PWM comparator and monostable						
I_{RCOFF}	Source current at pin RC_{OFF}	$V_{\text{RCOFF}} = 2.5\text{ V}$	3.5	5.5		mA
V_{OFFSET}	Offset voltage on sense comparator	$V_{\text{ref}} = 0.5\text{ V}$		± 5		mV
t_{prop}	Turn OFF propagation delay ⁽³⁾	$V_{\text{ref}} = 0.5\text{ V}$		500		ns
t_{blank}	Internal blanking time on sense comparator			1		μs
$t_{\text{ON(min)}}$	Minimum on time			1.5	2	μs
t_{OFF}	PWM recirculation time	$R_{\text{OFF}} = 20\text{ k}\Omega$; $C_{\text{OFF}} = 1\text{ nF}$		13		μs
		$R_{\text{OFF}} = 100\text{ k}\Omega$; $C_{\text{OFF}} = 1\text{ nF}$		61		μs
I_{BIAS}	Input bias current at pin V_{REF}				10	μA
TACHO monostable						
I_{RCPULSE}	Source current at pin RCPULSE	$V_{\text{RCPULSE}} = 2.5\text{ V}$	3.5	5.5		mA
t_{PULSE}	Monostable of time	$R_{\text{PUL}} = 20\text{ k}\Omega$; $C_{\text{PUL}} = 1\text{ nF}$		12		μs
		$R_{\text{PUL}} = 100\text{ k}\Omega$; $C_{\text{PUL}} = 1\text{ nF}$		60		μs
R_{TACHO}	Open drain ON resistance			40	60	Ω
Overcurrent detection and protection						
I_{SOVER}	Supply overcurrent protection threshold	$T_J = -25\text{ to }125\text{ °C}^{(1)}$	4.0	5.6	7.1	A
R_{OPDR}	Open drain ON resistance	$I_{\text{DIAG}} = 4\text{ mA}$		40	60	Ω
I_{OH}	OCD high level leakage current	$V_{\text{DIAG}} = 5\text{ V}$		1		μA
$t_{\text{OCD(ON)}}$	OCD turn-ON delay time ⁽⁴⁾	$I_{\text{DIAG}} = 4\text{ mA}$; $C_{\text{DIAG}} < 100\text{ pF}$		200		ns
$t_{\text{OCD(OFF)}}$	OCD turn-OFF delay time ⁽⁴⁾	$I_{\text{DIAG}} = 4\text{ mA}$; $C_{\text{DIAG}} < 100\text{ pF}$		100		ns

1. Tested at 25 °C in a restricted range and guaranteed by characterization.

2. See [Figure 3: Switching characteristic definition](#).

3. Measured applying a voltage of 1 V to pin SENSE and a voltage drop from 2 V to 0 V to pin VREF.

4. See [Figure 4: Overcurrent detection timing definition](#).

Figure 3. Switching characteristic definition

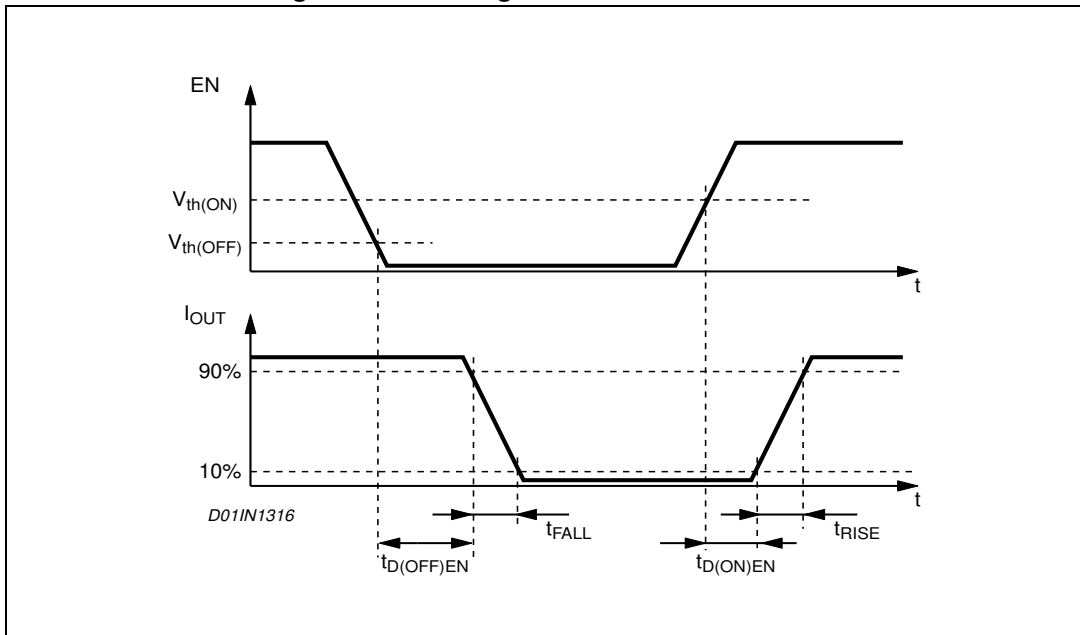
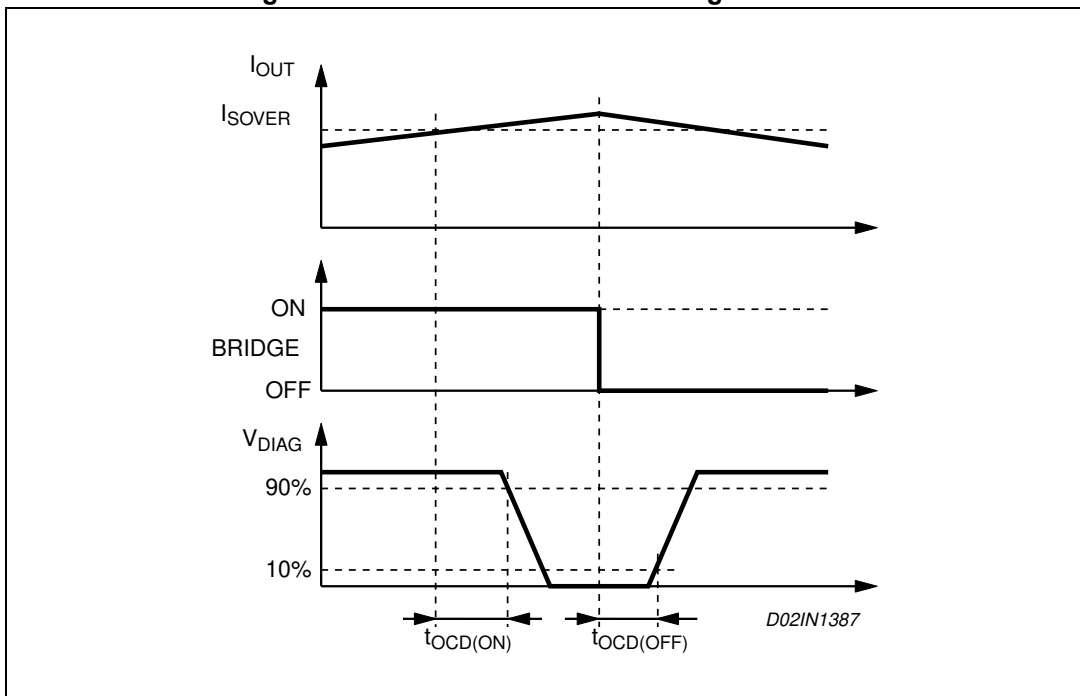


Figure 4. Overcurrent detection timing definition



5 Circuit description

5.1 Power stages and charge pump

The L6235 device integrates a 3-phase bridge, which consists of 6 power MOSFETs connected as shown in [Figure 1: Block diagram on page 3](#). Each power MOS has an $R_{DS(ON)} = 0.3$ (typical value at 25 °C) with intrinsic fast freewheeling diode. Switching patterns are generated by the PWM current controller and the hall effect sensor decoding logic (see [Section 6: PWM current control on page 13](#) and [Section 8: Decoding logic on page 18](#)). Cross conduction protection is implemented by using a deadtime ($t_{DT} = 1 \mu s$ typical value) set by internal timing circuit between the turn off and turn on of two power MOSFETs in one leg of a bridge.

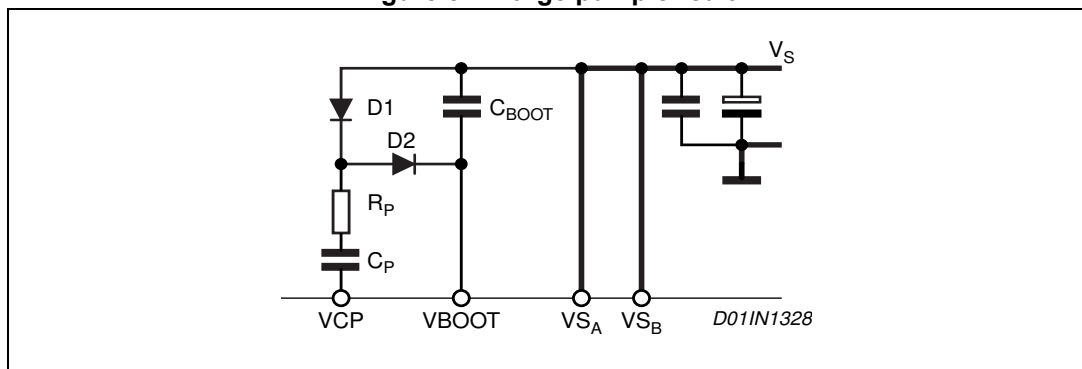
Pins VS_A and VS_B MUST be connected together to the supply voltage (V_S).

Using N-channel power MOS for the upper transistors in the bridge requires a gate drive voltage above the power supply voltage. The bootstrapped supply (V_{BOOT}) is obtained through an internal oscillator and few external components to realize a charge pump circuit as shown in [Figure 5](#). The oscillator output (pin VCP) is a square wave at 600 KHz (typically) with 10 V amplitude. Recommended values/part numbers for the charge pump circuit are shown in [Table 6](#).

Table 6. Charge pump external component values

Component	Value
C_{BOOT}	22 0nF
C_P	10 nF
R_P	100 Ω
D_1	1N4148
D_2	1N4148

Figure 5. Charge pump circuit



5.2 Logic inputs

Pins FWD/REV, BRAKE, EN, H₁, H₂ and H₃ are TTL/CMOS compatible logic inputs. The internal structure is shown in [Figure 6](#). Typical value for turn-ON and turn-OFF thresholds are respectively $V_{th(ON)} = 1.8\text{ V}$ and $V_{th(OFF)} = 1.3\text{ V}$.

Pin EN (enable) may be used to implement overcurrent and thermal protection by connecting it to the open collector DIAG output. If the protection and an external disable function are both desired, the appropriate connection must be implemented. When the external signal is from an open collector output, the circuit in [Figure 7](#) can be used. For external circuits that are push-pull outputs the circuit in [Figure 8](#) could be used. The resistor R_{EN} should be chosen in the range from 2.2 K Ω to 180 K Ω . Recommended values for R_{EN} and C_{EN} are respectively 100 K Ω and 5.6 nF. More information for selecting the values can be found in [Section 10: Non-dissipative overcurrent detection and protection on page 22](#).

Figure 6. Logic input internal structure

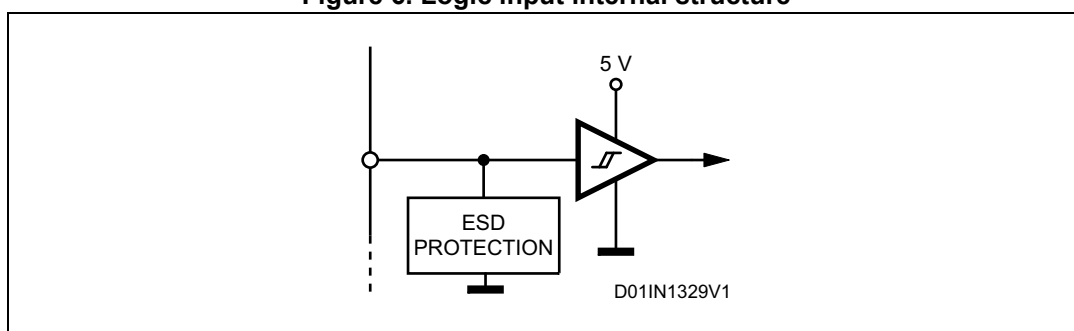


Figure 7. Pin EN open collector driving

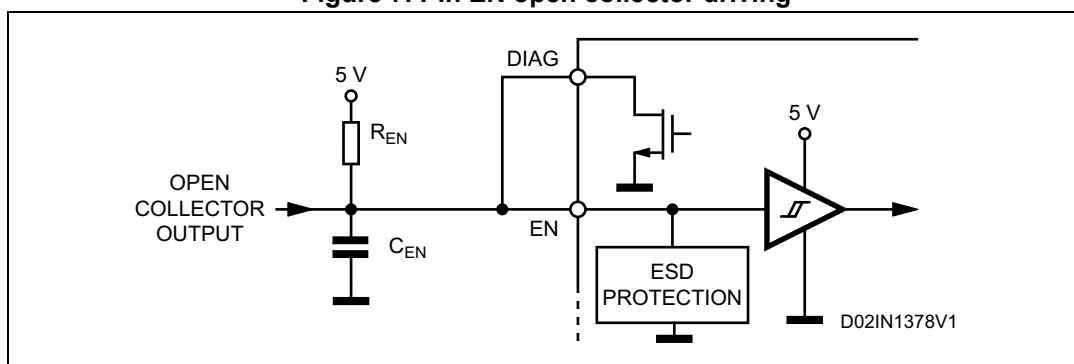


Figure 8. Pin EN push-pull driving

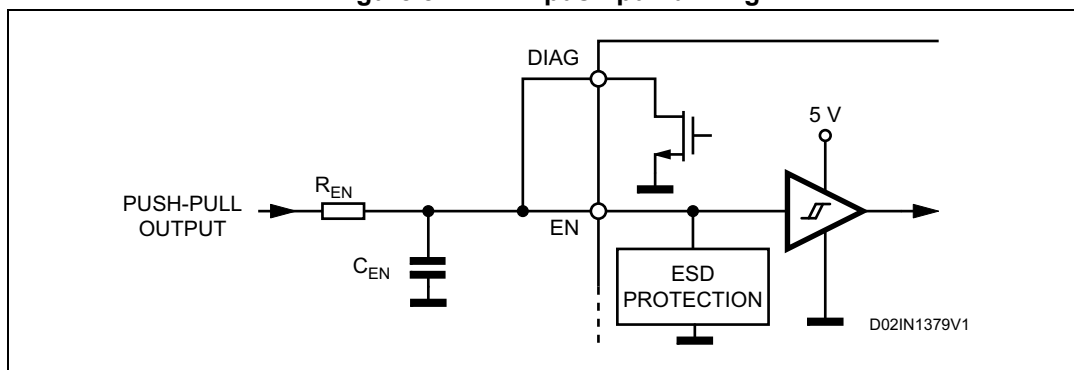


Figure 10. Output current regulation waveforms

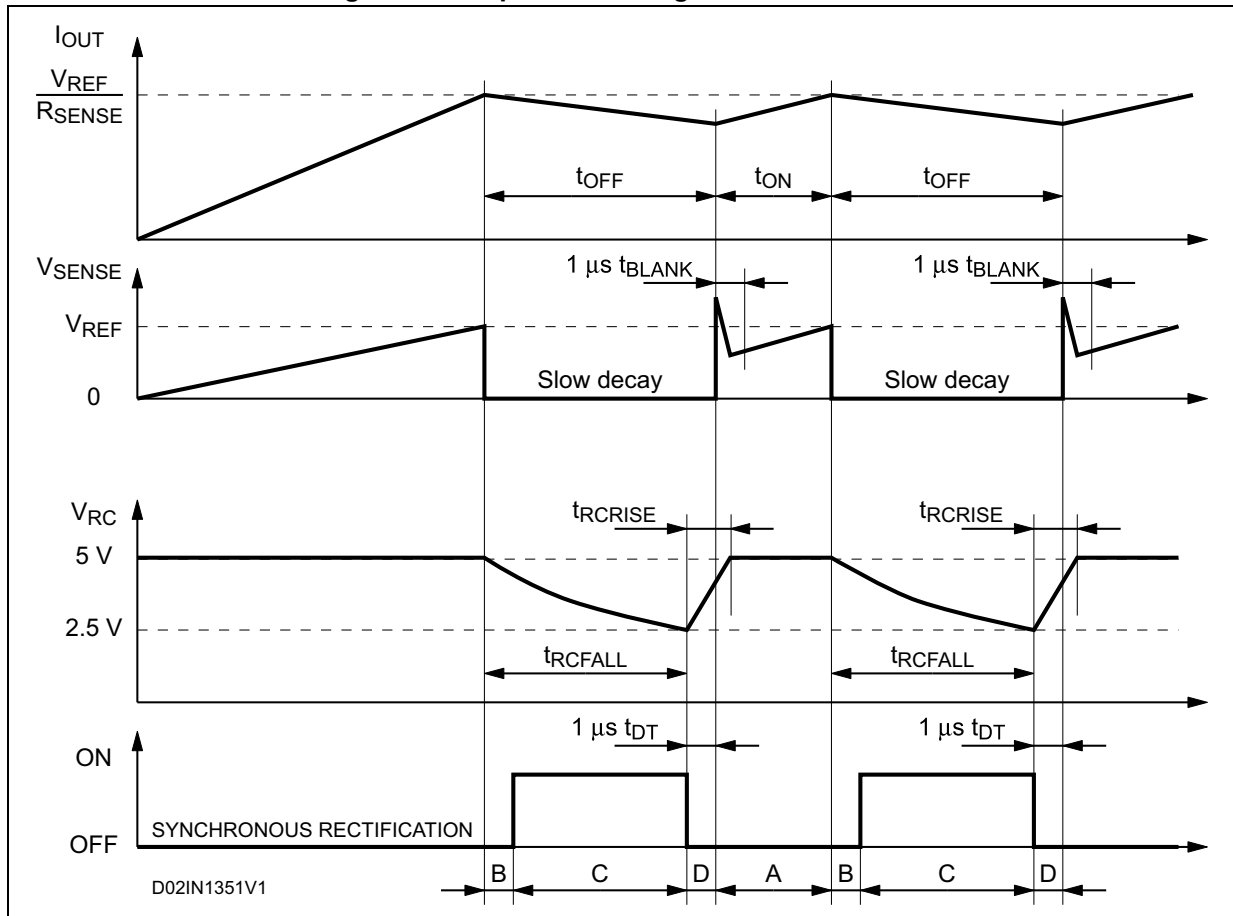


Figure 11 shows the magnitude of the off time t_{OFF} versus C_{OFF} and R_{OFF} values. It can be approximately calculated from the equations:

Equation 1

$$t_{RCFALL} = 0.6 \cdot R_{OFF} \cdot C_{OFF}$$

$$t_{OFF} = t_{RCFALL} + t_{DT} = 0.6 \cdot R_{OFF} \cdot C_{OFF} + t_{DT}$$

where R_{OFF} and C_{OFF} are the external component values and t_{DT} is the internally generated deadtime with:

Equation 2

$$20 \text{ K}\Omega \leq R_{OFF} \leq 100 \text{ K}\Omega$$

$$0.47 \text{ nF} \leq C_{OFF} \leq 100 \text{ nF}$$

$$t_{DT} = 1 \text{ }\mu\text{s (typical value)}$$

Therefore:

Equation 3

$$t_{OFF(MIN)} = 6.6 \text{ }\mu\text{s}$$

$$t_{OFF(MAX)} = 6 \text{ ms}$$

These values allow a sufficient range of t_{OFF} to implement the drive circuit for most motors.

The capacitor value chosen for C_{OFF} also affects the rise time t_{RCRISE} of the voltage at the pin RCOFF. The rise time t_{RCRISE} will only be an issue if the capacitor is not completely charged before the next time the monostable is triggered. Therefore, the on time t_{ON} , which depends by motors and supply parameters, has to be bigger than t_{RCRISE} for allowing a good current regulation by the PWM stage. Furthermore, the on time t_{ON} cannot be smaller than the minimum on time $t_{ON(MIN)}$.

Equation 4

$$\begin{cases} t_{ON} > t_{ON(MIN)} = 1.5\mu\text{s (typ. value)} \\ t_{ON} > t_{RCRISE} - t_{DT} \\ t_{RCRISE} = 600 \cdot C_{OFF} \end{cases}$$

Figure 12 shows the lower limit for the on time t_{ON} for having a good PWM current regulation capacity. It has to be said that t_{ON} is always bigger than $t_{ON(MIN)}$ because the device imposes this condition, but it can be smaller than $t_{RCRISE} - t_{DT}$. In this last case the device continues to work but the off time t_{OFF} is not more constant.

So, small C_{OFF} value gives more flexibility for the applications (allows smaller on time and, therefore, higher switching frequency), but, the smaller is the value for C_{OFF} , the more influential will be the noises on the circuit performance.

Figure 11. t_{OFF} versus C_{OFF} and R_{OFF}

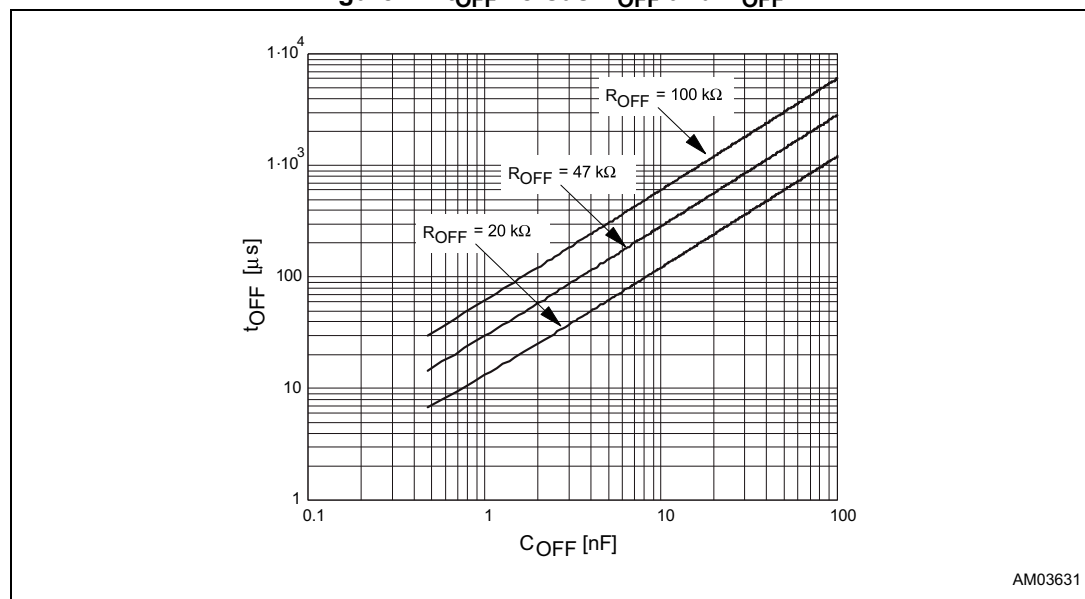
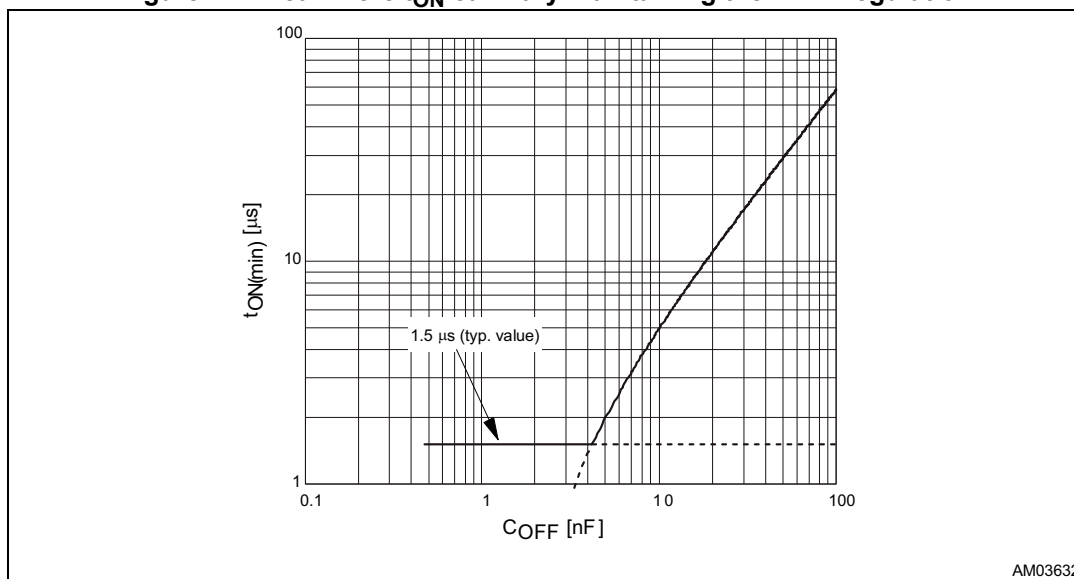


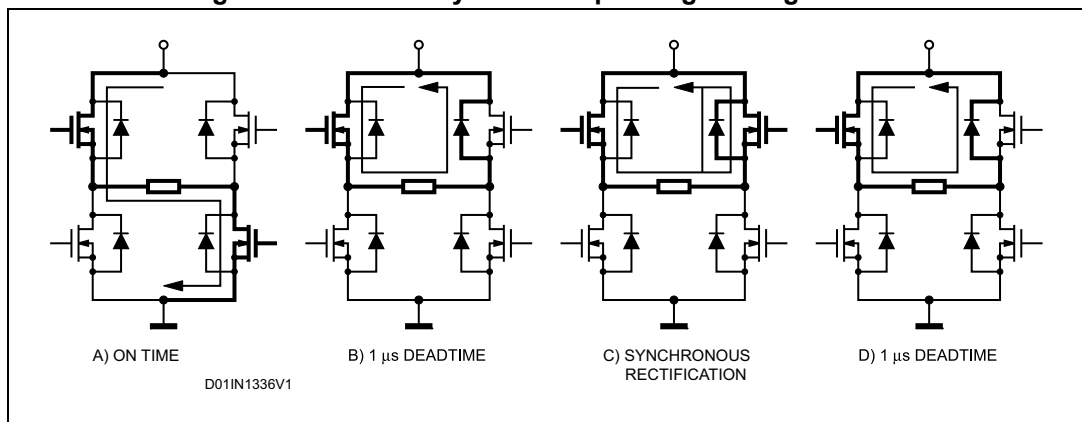
Figure 12. Area where t_{ON} can vary maintaining the PWM regulation



7 Slow decay mode

Figure 13 shows the operation of the bridge in the slow decay mode during the off time. At any time only two legs of the 3-phase bridge are active, therefore only the two active legs of the bridge are shown in *Figure 13* and the third leg will be off. At the start of the off time, the lower power MOS is switched off and the current recirculates around the upper half of the bridge. Since the voltage across the coil is low, the current decays slowly. After the deadtime the upper power MOS is operated in the synchronous rectification mode reducing the impedance of the freewheeling diode and the related conducting losses. When the monostable times out, upper MOS that was operating the synchronous mode turns off and the lower power MOS is turned on again after some delay set by the deadtime to prevent cross conduction.

Figure 13. Slow decay mode output stage configurations



8 Decoding logic

The decoding logic section is a combinatory logic that provides the appropriate driving of the 3-phase bridge outputs according to the signals coming from the three hall sensors that detect rotor position in a 3-phase BLDC motor. This novel combinatory logic discriminates between the actual sensor positions for sensors spaced at 60, 120, 240 and 300 electrical degrees. This decoding method allows the implementation of a universal IC without dedicating pins to select the sensor configuration.

There are eight possible input combinations for three sensor inputs. Six combinations are valid for rotor positions with 120 electrical degrees sensor phasing (see [Figure 14](#), positions 1, 2, 3a, 4, 5 and 6a) and six combinations are valid for rotor positions with 60 electrical degrees phasing (see [Figure 15](#), positions 1, 2, 3b, 4, 5 and 6b). Four of them are in common (1, 2, 4 and 5) whereas there are two combinations used only in 120 electrical degrees sensor phasing (3a and 6a) and two combinations used only in 60 electrical degrees sensor phasing (3b and 6b).

The decoder can drive motors with different sensor configuration simply by following [Table 7](#). For any input configuration (H_1 , H_2 and H_3) there is one output configuration (OUT_1 , OUT_2 and OUT_3). The output configuration 3a is the same as 3b and analogously output configuration 6a is the same as 6b.

The sequence of the hall codes for 300 electrical degrees phasing is the reverse of 60 and the sequence of the hall codes for 240 phasing is the reverse of 120. So, by decoding the 60 and the 120 codes it is possible to drive the motor with all the four conventions by changing the direction set.

Table 7. 60 and 120 electrical degree decoding logic in forward direction

Hall 120°	1	2	3a	-	4	5	6a	-
Hall 60°	1	2	-	3b	4	5	-	6b
H_1	H	H	L	H	L	L	H	L
H_2	L	H	H	H	H	L	L	L
H_3	L	L	L	H	H	H	H	L
OUT_1	Vs	High Z	GND	GND	GND	High Z	Vs	Vs
OUT_2	High Z	Vs	Vs	Vs	High Z	GND	GND	GND
OUT_3	GND	GND	High Z	High Z	Vs	Vs	High Z	High Z
Phasing	1 -> 3	2 -> 3	2 -> 1	2 -> 1	3 -> 1	3 -> 2	1 -> 2	1 -> 2

Figure 14. 120° hall sensor sequence

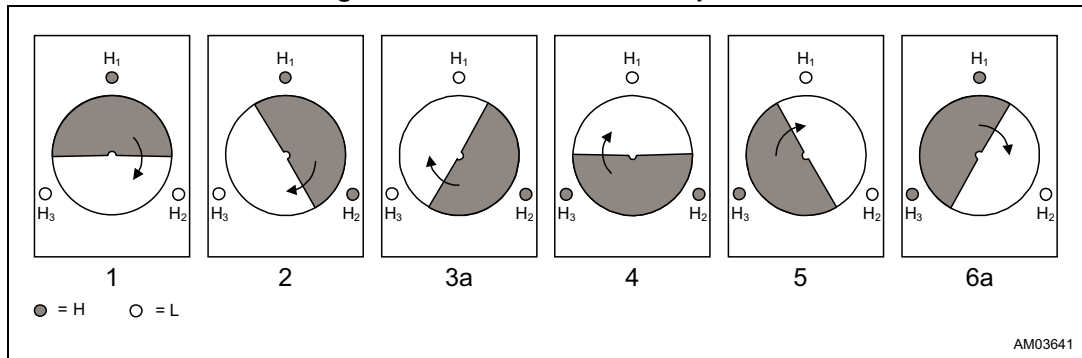
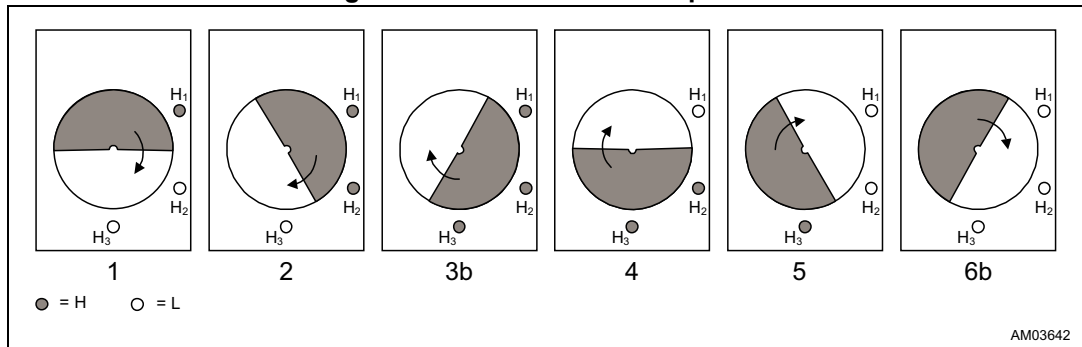


Figure 15. 60° hall sensor sequence



9 Tachometer

A tachometer function consists of a monostable, with constant off time (t_{PULSE}), whose input is one hall effect signal (H_1). It allows developing an easy speed control loop by using an external op amp, as shown in [Figure 16](#). For component values refer to [Section 11: Application information on page 25](#).

The monostable output drives an open drain output pin (TACHO). At each rising edge of the hall effect sensors H_1 , the monostable is triggered and the MOSFET connected to the pin TACHO is turned off for a constant time t_{PULSE} (see [Figure 17](#)). The off time t_{PULSE} can be set using the external RC network (R_{PUL} , C_{PUL}) connected to the pin RCPULSE. [Figure 18](#) gives the relation between t_{PULSE} and C_{PUL} , R_{PUL} . We have approximately:

Equation 5

$$t_{PULSE} = 0.6 \cdot R_{PUL} \cdot C_{PUL}$$

where C_{PUL} should be chosen in the range 1nF to 100 nF and R_{PUL} in the range 20 K Ω to 100 K Ω .

By connecting the tachometer pin to an external pull-up resistor, the output signal average value V_M is proportional to the frequency of the hall effect signal and, therefore, to the motor speed. This realizes a simple frequency-to-voltage converter. An op amp, configured as an integrator, filters the signal and compares it with a reference voltage V_{REF} , which sets the speed of the motor.

Equation 6

$$V_M = \frac{t_{PULSE}}{T} \cdot V_{DD}$$

Figure 16. TACHO operation waveforms

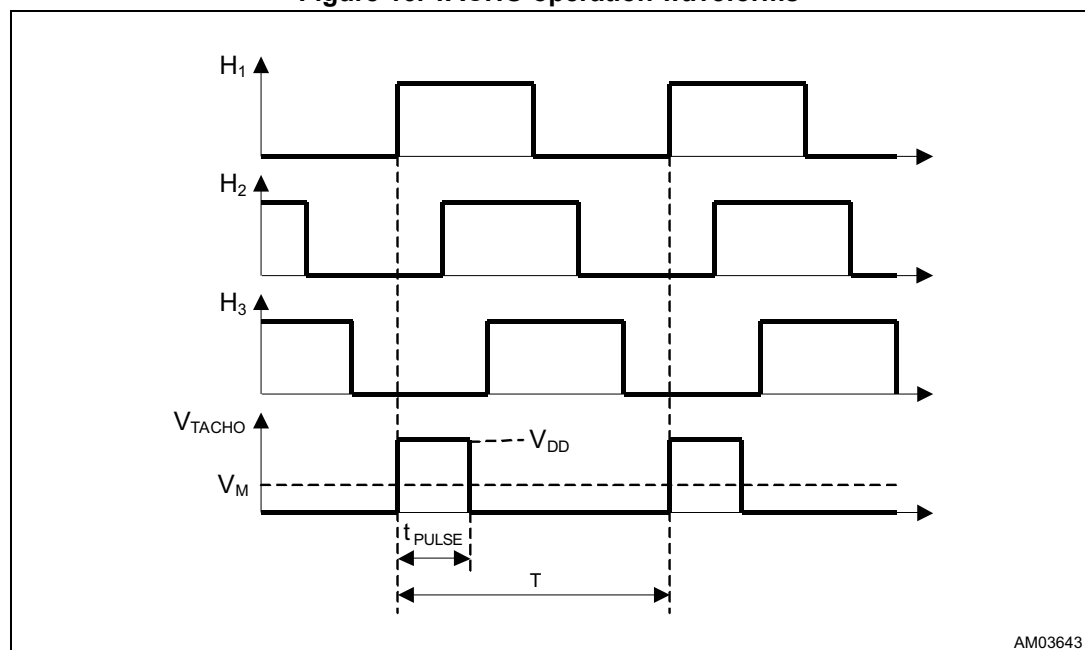
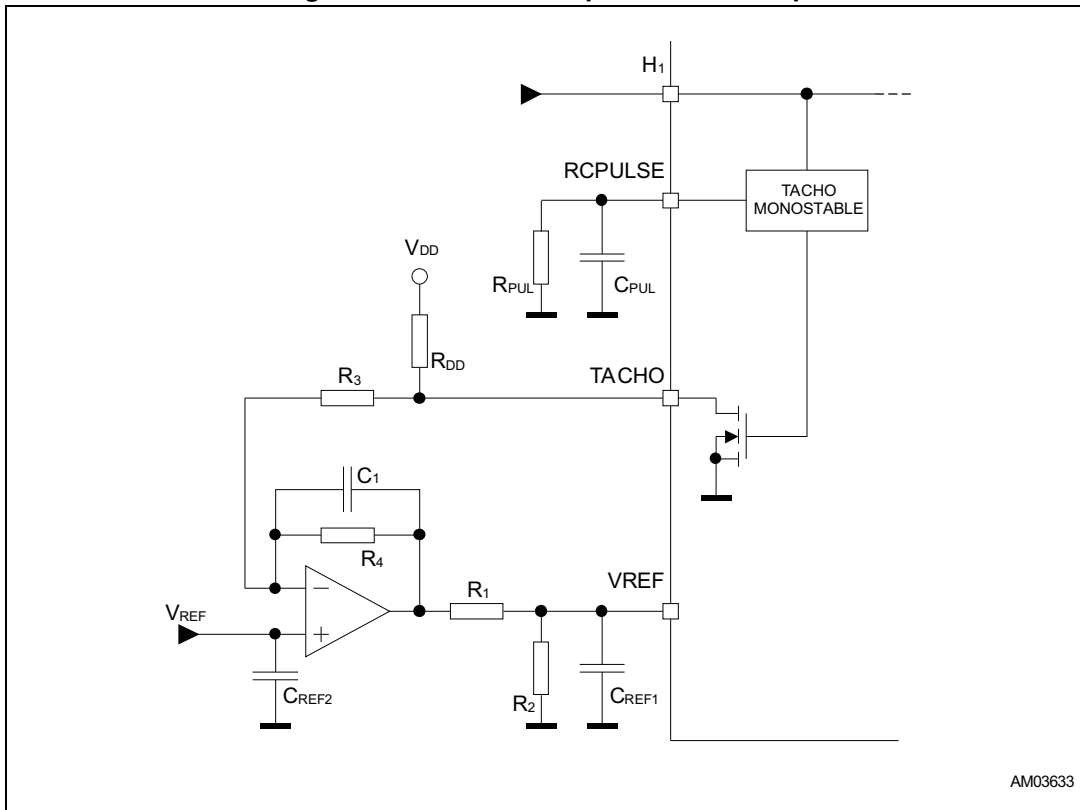
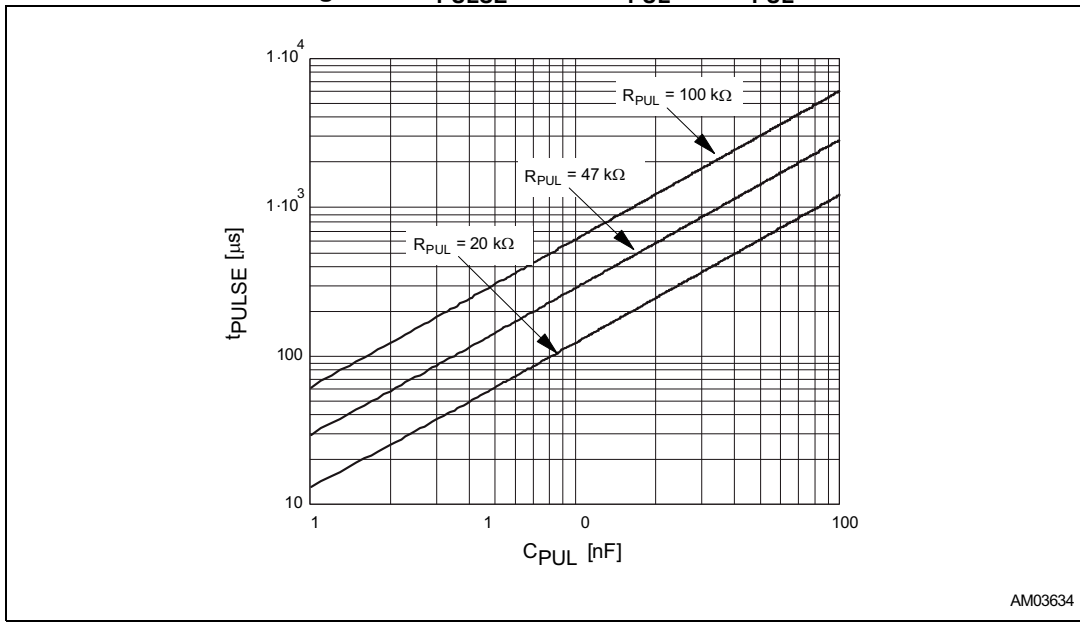


Figure 17. Tachometer speed control loop



AM03633

Figure 18. t_{PULSE} versus C_{PUL} and R_{PUL}



AM03634

10 Non-dissipative overcurrent detection and protection

The L6235 device integrates an “Overcurrent Detection” circuit (OCD) for full protection. This circuit provides output to output and output to ground short-circuit protection as well. With this internal overcurrent detection, the external current sense resistor normally used and its associated power dissipation are eliminated. *Figure 19* shows a simplified schematic for the overcurrent detection circuit.

To implement the overcurrent detection, a sensing element that delivers a small but precise fraction of the output current is implemented with each high-side power MOS. Since this current is a small fraction of the output current there is very little additional power dissipation. This current is compared with an internal reference current I_{REF} . When the output current reaches the detection threshold (typically $I_{SOVER} = 5.6\text{ A}$) the OCD comparator signals a fault condition. When a fault condition is detected, an internal open drain MOS with a pull down capability of 4 mA connected to pin DIAG is turned on.

The pin DIAG can be used to signal the fault condition to a μC or to shut down the 3-phase bridge simply by connecting it to pin EN and adding an external R-C (see R_{EN} , C_{EN}).

Figure 19. Overcurrent protection simplified schematic

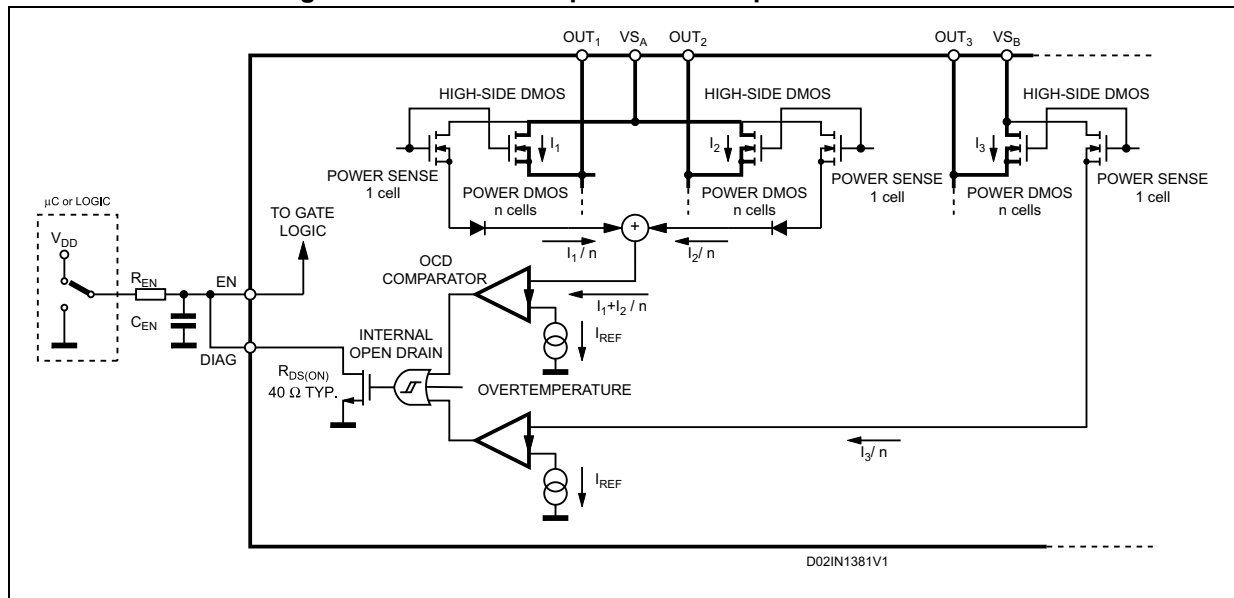


Figure 20 shows the overcurrent detection operation. The disable time $t_{DISABLE}$ before recovering normal operation can be easily programmed by means of the accurate thresholds of the logic inputs. It is affected whether by C_{EN} and R_{EN} values and its magnitude is reported in *Figure 21*. The delay time t_{DELAY} before turning off the bridge when an overcurrent has been detected depends only by C_{EN} value. Its magnitude is reported in *Figure 22*.

C_{EN} is also used for providing immunity to pin EN against fast transient noises. Therefore the value of C_{EN} should be chosen as big as possible according to the maximum tolerable delay time and the R_{EN} value should be chosen according to the desired disable time.

The resistor R_{EN} should be chosen in the range from 2.2 K Ω to 180 K Ω . Recommended values for R_{EN} and C_{EN} are respectively 100 K Ω and 5.6 nF that allow obtaining 200 μs disable time.

Figure 20. Overcurrent protection waveforms

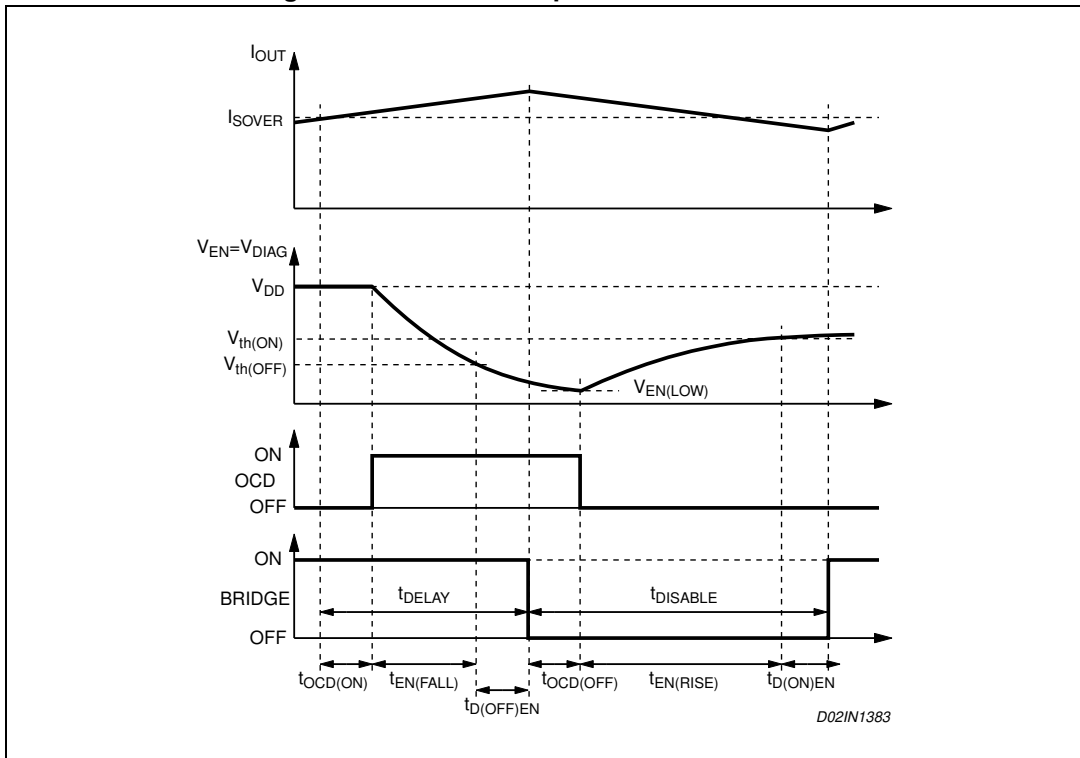


Figure 21. t_{DISABLE} versus C_{EN} and R_{EN}

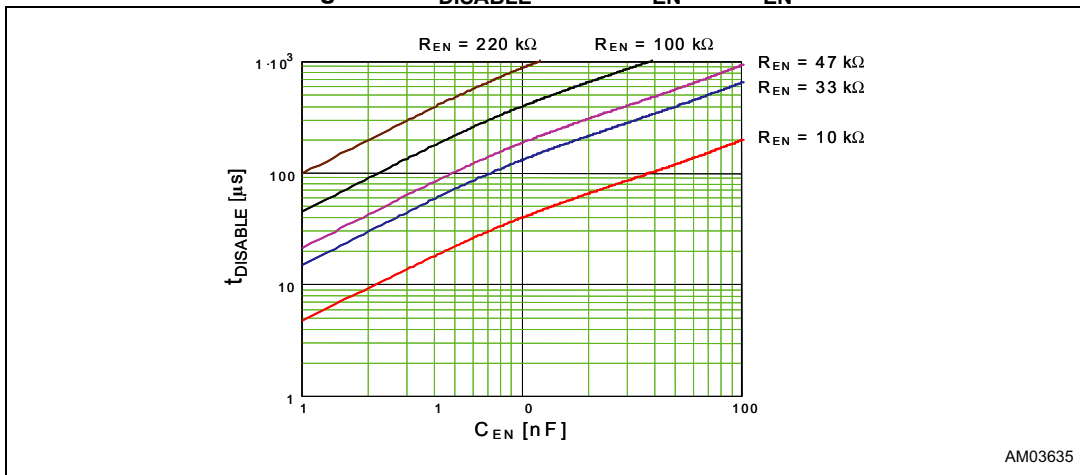
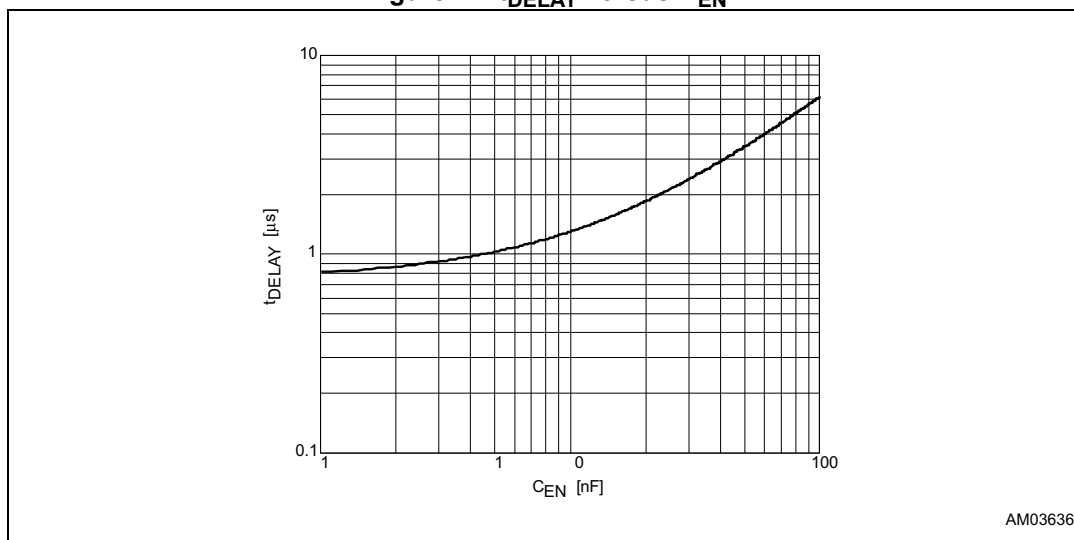


Figure 22. t_{DELAY} versus C_{EN}



11 Application information

A typical application using the L6235 device is shown in [Figure 23](#). Typical component values for the application are shown in [Table 8](#). A high quality ceramic capacitor (C_2) in the range of 100 nF to 200 nF should be placed between the power pins VS_A and VS_B and ground near the L6235 device to improve the high frequency filtering on the power supply and reduce high frequency transients generated by the switching. The capacitor (C_{EN}) connected from the EN input to ground sets the shutdown time when an overcurrent is detected (see [Section 10: Non-dissipative overcurrent detection and protection](#)). The two current sensing inputs ($SENSE_A$ and $SENSE_B$) should be connected to the sensing resistor R_{SENSE} with a trace length as short as possible in the layout. The sense resistor should be non-inductive resistor to minimize the di/dt transients across the resistor. To increase noise immunity, unused logic pins are best connected to 5 V (high logic level) or GND (low logic level) (see [Table 4: Pin description on page 6](#)). It is recommended to keep power ground and signal ground separated on the PCB.

Table 8. Component values for typical application

Component	Value
C_1	100 μ F
C_2	100 nF
C_3	220 nF
C_{BOOT}	220 nF
C_{OFF}	1 nF
C_{PUL}	10 nF
C_{REF1}	33 nF
C_{REF2}	100 nF
C_{EN}	5.6 nF
C_P	10 nF
D_1	1N4148
D_2	1N4148
R_1	5.6 K Ω
R_2	1.8 K Ω
R_3	4.7 K Ω
R_4	1 M Ω
R_{DD}	1 K Ω
R_{EN}	100 K Ω
R_P	100 Ω
R_{SENSE}	0.3 Ω
R_{OFF}	33 K Ω
R_{PUL}	47 K Ω
R_{H1}, R_{H2}, R_{H3}	10 K Ω